

## SM73201 16-Bit, 50 to 250 kSPS, Differential Input, MicroPower ADC

Check for Samples: [SM73201](#)

### FEATURES

- Renewable Energy Grade
- Specified Performance from 50 to 250 kSPS
- Separate Digital Input/Output Supply
- True Differential Input
- External Voltage Reference Range of +0.5V to  $V_A$
- Wide Input Common-Mode Voltage Range of 0V to  $V_A$
- SPI™/ QSPI™/MICROWIRE Compatible Serial Interface
- Operating Temperature Range of  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$
- Small VSSOP-10 Package

### APPLICATIONS

- PV DC Arc Detect System
- I/O Modules
- Solar Data Acquisition
- Instrumentation and Control Systems

### KEY SPECIFICATIONS

- Conversion Rate: 50 kSPS to 250 kSPS
- SNR: 93.2 dBc
- SFDR: 108 dBc
- THD:  $-104$  dBc
- Power Consumption
  - 200 kSPS, 5V: 5.3 mW
  - 250 kSPS, 5V: 5.8 mW
  - Power-Down, 5V: 10  $\mu\text{W}$

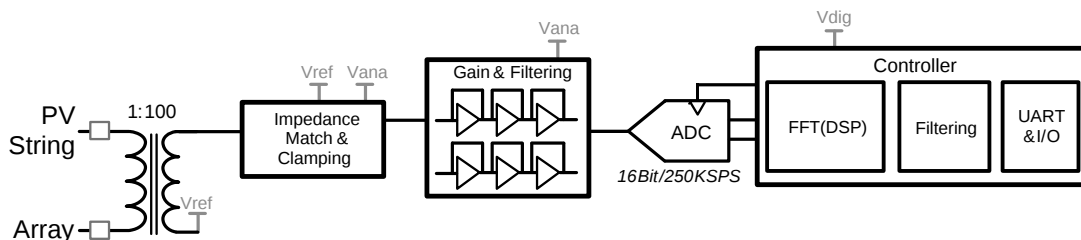
### DESCRIPTION

The SM73201 is a 16-bit successive-approximation register (SAR) Analog-to-Digital converter (ADC) with a maximum sampling rate of 250 kSPS. The converter features a differential analog input with an excellent common-mode signal rejection ratio of 85 dB, making the SM73201 suitable for noisy environments.

The SM73201 operates with a single analog supply ( $V_A$ ) and a separate digital input/output ( $V_{IO}$ ) supply.  $V_A$  can range from +4.5V to +5.5V and  $V_{IO}$  can range from +2.7V to +5.5V. This allows a system designer to maximize performance and minimize power consumption by operating the analog portion of the ADC at a  $V_A$  of +5V while interfacing with a +3.3V controller. The serial data output is binary 2's complement and is SPI compatible.

The performance of the SM73201 is specified over temperature at clock rates of 1 MHz to 5 MHz and reference voltages of +2.5V to +5.5V. The SM73201 is available in a small 10-lead VSSOP package. The high accuracy, differential input, low power consumption, and small size make the SM73201 ideal for direct connection to bridge sensors and transducers in battery operated systems or remote data acquisition applications.

### Typical Application



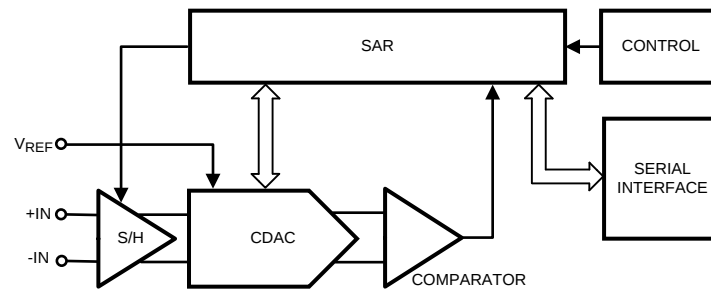
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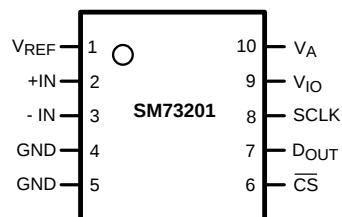
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### Block Diagram



### Connection Diagram



**Figure 1. 10-Lead VSSOP**  
**See Package Number DGS0010A**

## Pin Descriptions

| Pin No. | Name                   | Description                                                    |
|---------|------------------------|----------------------------------------------------------------|
| 1       | V <sub>REF</sub>       | Voltage Reference<br>+0.5V < V <sub>REF</sub> < V <sub>A</sub> |
| 2       | +IN                    | Non-Inverting Input                                            |
| 3       | -IN                    | Inverting Input                                                |
| 4       | GND                    | Ground                                                         |
| 5       | GND                    | Ground                                                         |
| 6       | $\overline{\text{CS}}$ | Chip Select Bar                                                |
| 7       | D <sub>OUT</sub>       | Serial Data Output                                             |
| 8       | SCLK                   | Serial Clock                                                   |
| 9       | V <sub>IO</sub>        | Digital Input/Output Power<br>+2.7V < V <sub>REF</sub> < +5.5V |
| 10      | V <sub>A</sub>         | Analog Power<br>+4.5V < V <sub>REF</sub> < +5.5V               |



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### Absolute Maximum Ratings<sup>(1)(2)(3)</sup>

|                                               |                              |
|-----------------------------------------------|------------------------------|
| Analog Supply Voltage $V_A$                   | –0.3V to 6.5V                |
| Digital I/O Supply Voltage $V_{IO}$           | –0.3V to 6.5V                |
| Voltage on Any Analog Input Pin to GND        | –0.3V to ( $V_A + 0.3V$ )    |
| Voltage on Any Digital Input Pin to GND       | –0.3V to ( $V_{IO} + 0.3V$ ) |
| Input Current at Any Pin <sup>(4)</sup>       | ±10 mA                       |
| Package Input Current <sup>(4)</sup>          | ±50 mA                       |
| Power Consumption at $T_A = 25^\circ\text{C}$ | See <sup>(5)</sup>           |
| ESD Susceptibility <sup>(6)</sup>             |                              |
| Human Body Model                              | 2500V                        |
| Machine Model                                 | 250V                         |
| Charge Device Model                           | 1250V                        |
| Junction Temperature                          | +150°C                       |
| Storage Temperature                           | –65°C to +150°C              |

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions. Operation of the device beyond the maximum Operating Ratings is not recommended.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications
- (3) All voltages are measured with respect to GND = 0V, unless otherwise specified.
- (4) When the input voltage at any pin exceeds the power supplies (that is,  $V_{IN} < \text{GND}$  or  $V_{IN} > V_A$ ), the current at that pin should be limited to 10 mA. The 50 mA maximum package input current rating limits the number of pins that can safely exceed the power supplies with an input current of 10 mA to five.
- (5) The absolute maximum junction temperature ( $T_{Jmax}$ ) for this device is 150°C. The maximum allowable power dissipation is dictated by  $T_{Jmax}$ , the junction-to-ambient thermal resistance ( $\theta_{JA}$ ), and the ambient temperature ( $T_A$ ), and can be calculated using the formula  $P_{DMAX} = (T_{Jmax} - T_A)/\theta_{JA}$ . The values for maximum power dissipation listed above will be reached only when the SM73201 is operated in a severe fault condition (e.g. when input or output pins are driven beyond the power supply voltages, or the power supply polarity is reversed). Such conditions should always be avoided.
- (6) Human body model is a 100 pF capacitor discharged through a 1.5 kΩ resistor. Machine model is a 220 pF capacitor discharged through 0 Ω. Charge device model simulates a pin slowly acquiring charge (such as from a device sliding down the feeder in an automated assembler) then rapidly being discharged.

### Operating Ratings<sup>(1)(2)</sup>

|                                     |                                                         |
|-------------------------------------|---------------------------------------------------------|
| Operating Temperature Range         | $-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$     |
| Supply Voltage, $V_A$               | +4.5V to +5.5V                                          |
| Supply Voltage, $V_{IO}$            | +2.7V to +5.5V                                          |
| Reference Voltage, $V_{REF}$        | +0.5V to $V_A$                                          |
| Analog Input Pins Voltage Range     | 0V to $V_A$                                             |
| Differential Analog Input Voltage   | – $V_{REF}$ to + $V_{REF}$                              |
| Input Common-Mode Voltage, $V_{CM}$ | See <a href="#">Figure 31 Input Common Mode Voltage</a> |
| Digital Input Pins Voltage Range    | 0V to $V_{IO}$                                          |
| Clock Frequency                     | 1 MHz to 5 MHz                                          |

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions. Operation of the device beyond the maximum Operating Ratings is not recommended.
- (2) All voltages are measured with respect to GND = 0V, unless otherwise specified.

## Package Thermal Resistance

| Package       | $\theta_{JA}$ |
|---------------|---------------|
| 10-lead VSSOP |               |

Soldering process must comply with Reflow Temperature Profile specifications. Refer to [SNOA549](#) Reflow temperature profiles are different for lead-free packages.

## SM73201 Converter Electrical Characteristics<sup>(1)</sup>

The following specifications apply for  $V_A = 4.5V$  to  $5.5V$ ,  $V_{IO} = 2.7V$  to  $5.5V$ , and  $V_{REF} = 2.5V$  to  $5.5V$  for  $f_{SCLK} = 1\text{ MHz}$  to  $4\text{ MHz}$  or  $V_{REF} = 4.5V$  to  $5.5V$  for  $f_{SCLK} = 1\text{ MHz}$  to  $5\text{ MHz}$ ;  $f_{IN} = 20\text{ kHz}$ , and  $C_L = 25\text{ pF}$ , unless otherwise noted. Maximum and minimum values apply for  $T_A = T_{MIN}$  to  $T_{MAX}$ ; the typical values apply for  $T_A = 25^\circ\text{C}$ .

| Parameter                         |                                       | Test Conditions                                                        | Min               | Typ       | Max               | Units  |
|-----------------------------------|---------------------------------------|------------------------------------------------------------------------|-------------------|-----------|-------------------|--------|
| STATIC CONVERTER CHARACTERISTICS  |                                       |                                                                        |                   |           |                   |        |
|                                   | Resolution                            |                                                                        |                   |           | 16                | Bits   |
| DNL                               | Differential Non-Linearity            |                                                                        |                   | -0.5/+0.8 |                   | LSB    |
| INL                               | Integral Non-Linearity                |                                                                        |                   | ±0.8      |                   | LSB    |
| OE                                | Offset Error                          | V <sub>REF</sub> = 2.5V                                                |                   | -0.1      |                   | mV     |
|                                   |                                       | V <sub>REF</sub> = 5V                                                  |                   | -0.4      |                   | mV     |
| OE <sub>DRIFT</sub>               | Offset Error Temperature Drift        | V <sub>REF</sub> = 2.5V                                                |                   | 3.7       |                   | μV/°C  |
|                                   |                                       | V <sub>REF</sub> = 5V                                                  |                   | 2.5       |                   | μV/°C  |
| FSE                               | Positive Full-Scale Error             |                                                                        |                   | -0.003    |                   | %FS    |
|                                   | Negative Full-Scale Error             |                                                                        |                   | -0.002    |                   | %FS    |
| GE                                | Positive Gain Error                   |                                                                        |                   | -0.002    |                   | %FS    |
|                                   | Negative Gain Error                   |                                                                        |                   | -0.0001   |                   | %FS    |
| GE <sub>DRIFT</sub>               | Gain Error Temperature Drift          |                                                                        |                   | 0.3       |                   | ppm/°C |
| DYNAMIC CONVERTER CHARACTERISTICS |                                       |                                                                        |                   |           |                   |        |
| SINAD                             | Signal-to-Noise Plus Distortion Ratio | V <sub>REF</sub> = 2.5V                                                | 85                | 88        |                   | dBc    |
|                                   |                                       | V <sub>REF</sub> = 4.5V to 5.5V                                        | 89                | 93.0      |                   | dBc    |
| SNR                               | Signal-to-Noise Ratio                 | V <sub>REF</sub> = 2.5V                                                | 85                | 88        |                   | dBc    |
|                                   |                                       | V <sub>REF</sub> = 4.5V to 5.5V                                        | 89                | 93.2      |                   | dBc    |
| THD                               | Total Harmonic Distortion             | V <sub>REF</sub> = 2.5V                                                |                   | -104      |                   | dBc    |
|                                   |                                       | V <sub>REF</sub> = 4.5V to 5.5V                                        |                   | -106      |                   | dBc    |
| SFDR                              | Spurious-Free Dynamic Range           | V <sub>REF</sub> = 2.5V                                                |                   | 108       |                   | dBc    |
|                                   |                                       | V <sub>REF</sub> = 4.5V to 5.5V                                        |                   | 111       |                   | dBc    |
| ENOB                              | Effective Number of Bits              | V <sub>REF</sub> = 2.5V                                                | 13.8              | 14.3      |                   | bits   |
|                                   |                                       | V <sub>REF</sub> = 4.5V to 5.5V                                        | 14.5              | 15.2      |                   | bits   |
| ANALOG INPUT CHARACTERISTICS      |                                       |                                                                        |                   |           |                   |        |
| V <sub>IN</sub>                   | Differential Input Range              |                                                                        | -V <sub>REF</sub> |           | +V <sub>REF</sub> | V      |
| I <sub>INA</sub>                  | Analog Input Current                  | $\overline{\text{CS}}$ high                                            |                   |           | ±1                | μA     |
|                                   |                                       | V <sub>REF</sub> = 5V, V <sub>IN</sub> = 0V, f <sub>S</sub> = 50 kSPS  |                   | 3.2       |                   | nA     |
|                                   |                                       | V <sub>REF</sub> = 5V, V <sub>IN</sub> = 0V, f <sub>S</sub> = 200 kSPS |                   | 10.3      |                   | nA     |
| C <sub>INA</sub>                  | Input Capacitance (+IN or -IN)        | In Acquisition Mode                                                    |                   | 20        |                   | pF     |
|                                   |                                       | In Conversion Mode                                                     |                   | 4         |                   | pF     |
| CMRR                              | Common Mode Rejection Ratio           | See the Specification Definitions for the test condition               |                   | 85        |                   | dB     |

(1) Typical values are at  $T_J = 25^\circ\text{C}$  and represent most likely parametric norms. Test limits are ensured to TI's AOQL (Average Outgoing Quality Level).

**SM73201 Converter Electrical Characteristics<sup>(1)</sup> (continued)**

The following specifications apply for  $V_A = 4.5V$  to  $5.5V$ ,  $V_{IO} = 2.7V$  to  $5.5V$ , and  $V_{REF} = 2.5V$  to  $5.5V$  for  $f_{SCLK} = 1$  MHz to 4 MHz or  $V_{REF} = 4.5V$  to  $5.5V$  for  $f_{SCLK} = 1$  MHz to 5 MHz;  $f_{IN} = 20$  kHz, and  $C_L = 25$  pF, unless otherwise noted. Maximum and minimum values apply for  $T_A = T_{MIN}$  to  $T_{MAX}$ ; the typical values apply for  $T_A = 25^\circ C$ .

| Parameter                           |                                                       | Test Conditions                                                                                          | Min                   | Typ                    | Max                   | Units |
|-------------------------------------|-------------------------------------------------------|----------------------------------------------------------------------------------------------------------|-----------------------|------------------------|-----------------------|-------|
| DIGITAL INPUT CHARACTERISTICS       |                                                       |                                                                                                          |                       |                        |                       |       |
| V <sub>IH</sub>                     | Input High Voltage                                    | f <sub>IN</sub> = 0 Hz                                                                                   | 0.7 x V <sub>IO</sub> | 1.9                    |                       | V     |
| V <sub>IL</sub>                     | Input Low Voltage                                     | f <sub>IN</sub> = 0 Hz                                                                                   |                       | 1.7                    | 0.3 x V <sub>IO</sub> | V     |
| I <sub>IND</sub>                    | Digital Input Current                                 |                                                                                                          |                       |                        | ±1                    | µA    |
| C <sub>IND</sub>                    | Input Capacitance                                     |                                                                                                          |                       |                        | 4                     | pF    |
| DIGITAL OUTPUT CHARACTERISTICS      |                                                       |                                                                                                          |                       |                        |                       |       |
| V <sub>OH</sub>                     | Output High Voltage                                   | I <sub>SOURCE</sub> = 200 µA                                                                             | V <sub>IO</sub> – 0.2 | V <sub>IO</sub> – 0.03 |                       | V     |
|                                     |                                                       | I <sub>SOURCE</sub> = 1 mA                                                                               |                       | V <sub>IO</sub> – 0.09 |                       | V     |
| V <sub>OL</sub>                     | Output Low Voltage                                    | I <sub>SOURCE</sub> = 200 µA                                                                             |                       | 0.01                   | 0.4                   | V     |
|                                     |                                                       | I <sub>SOURCE</sub> = 1 mA                                                                               |                       | 0.07                   |                       | V     |
| I <sub>OZH</sub> , I <sub>OZL</sub> | TRI-STATE Leakage Current                             | Force 0V or V <sub>A</sub>                                                                               |                       |                        | ±1                    | µA    |
| C <sub>OUT</sub>                    | TRI-STATE Output Capacitance                          | Force 0V or V <sub>A</sub>                                                                               |                       | 4                      |                       | pF    |
|                                     | Output Coding                                         |                                                                                                          |                       | Binary 2'S Complement  |                       |       |
| POWER SUPPLY CHARACTERISTICS        |                                                       |                                                                                                          |                       |                        |                       |       |
| V <sub>A</sub>                      | Analog Supply Voltage Range                           |                                                                                                          | 4.5                   | 5                      | 5.5                   | V     |
| V <sub>IO</sub>                     | Digital Input/Output Supply Voltage Range             | See <sup>(2)</sup>                                                                                       | 2.7                   | 3                      | 5.5                   | V     |
| V <sub>REF</sub>                    | Reference Voltage Range                               |                                                                                                          | 0.5                   | 5                      | V <sub>A</sub>        | V     |
| I <sub>VA</sub> (Conv)              | Analog Supply Current, Conversion Mode                | V <sub>A</sub> = 5V, f <sub>SCLK</sub> = 4 MHz, f <sub>S</sub> = 200 kSPS                                |                       | 1060                   |                       | µA    |
|                                     |                                                       | V <sub>A</sub> = 5V, f <sub>SCLK</sub> = 5 MHz, f <sub>S</sub> = 250 kSPS                                |                       | 1160                   | 1340                  | µA    |
| I <sub>VIO</sub> (Conv)             | Digital I/O Supply Current, Conversion Mode           | V <sub>IO</sub> = 3V, f <sub>SCLK</sub> = 4 MHz, f <sub>S</sub> = 200 kSPS                               |                       | 80                     |                       | µA    |
|                                     |                                                       | V <sub>IO</sub> = 3V, f <sub>SCLK</sub> = 5 MHz, f <sub>S</sub> = 250 kSPS                               |                       | 100                    |                       | µA    |
| I <sub>VREF</sub> (Conv)            | Reference Current, Conversion Mode                    | V <sub>A</sub> = 5V, f <sub>SCLK</sub> = 4 MHz, f <sub>S</sub> = 200 kSPS                                |                       | 80                     |                       | µA    |
|                                     |                                                       | V <sub>A</sub> = 5V, f <sub>SCLK</sub> = 5 MHz, f <sub>S</sub> = 250 kSPS                                |                       | 100                    | 170                   | µA    |
| I <sub>VA</sub> (PD)                | Analog Supply Current, Power Down Mode (CS high)      | f <sub>SCLK</sub> = 5 MHz, V <sub>A</sub> = 5V                                                           |                       | 7                      |                       | µA    |
|                                     |                                                       | f <sub>SCLK</sub> = 0 Hz, V <sub>A</sub> = 5V <sup>(3)</sup>                                             |                       | 2                      | 3                     | µA    |
| I <sub>VIO</sub> (PD)               | Digital I/O Supply Current, Power Down Mode (CS high) | f <sub>SCLK</sub> = 5 MHz, V <sub>IO</sub> = 3V                                                          |                       | 1                      |                       | µA    |
|                                     |                                                       | f <sub>SCLK</sub> = 0 Hz, V <sub>IO</sub> = 3V <sup>(3)</sup>                                            |                       | 0.3                    | 0.5                   | µA    |
| I <sub>VREF</sub> (PD)              | Reference Current, Power Down Mode (CS high)          | f <sub>SCLK</sub> = 5 MHz, V <sub>REF</sub> = 5V                                                         |                       | 0.5                    |                       | µA    |
|                                     |                                                       | f <sub>SCLK</sub> = 0 Hz, V <sub>REF</sub> = 5V <sup>(3)</sup>                                           |                       | 0.5                    | 0.7                   | µA    |
| PWR (Conv)                          | Power Consumption, Conversion Mode                    | V <sub>A</sub> = 5V, f <sub>SCLK</sub> = 4 MHz, f <sub>S</sub> = 200 kSPS, and f <sub>IN</sub> = 20 kHz, |                       | 5.3                    |                       | mW    |
|                                     |                                                       | V <sub>A</sub> = 5V, f <sub>SCLK</sub> = 5 MHz, f <sub>S</sub> = 250 kSPS, and f <sub>IN</sub> = 20      |                       | 5.8                    | 6.7                   | mW    |
| PWR (PD)                            | Power Consumption, Power Down Mode (CS high)          | f <sub>SCLK</sub> = 5 MHz, V <sub>A</sub> = 5.0V <sup>(3)</sup>                                          |                       | 35                     |                       | µW    |
|                                     |                                                       | f <sub>SCLK</sub> = 0 Hz, V <sub>A</sub> = 5.0V <sup>(3)</sup>                                           |                       | 10                     | 15                    | µW    |
| PSRR                                | Power Supply Rejection Ratio                          | See the Specification Definitions for the test condition                                                 |                       | –78                    |                       | dB    |

(2) The value of  $V_{IO}$  is independent of the value of  $V_A$ . For example,  $V_{IO}$  could be operating at 5.5V while  $V_A$  is operating at 4.5V or  $V_{IO}$  could be operating at 2.7V while  $V_A$  is operating at 5.5V.

(3) This parameter is ensured by design and/or characterization and is not tested in production.

## SM73201 Converter Electrical Characteristics<sup>(1)</sup> (continued)

The following specifications apply for  $V_A = 4.5\text{V}$  to  $5.5\text{V}$ ,  $V_{IO} = 2.7\text{V}$  to  $5.5\text{V}$ , and  $V_{REF} = 2.5\text{V}$  to  $5.5\text{V}$  for  $f_{SCLK} = 1\text{ MHz}$  to  $4\text{ MHz}$  or  $V_{REF} = 4.5\text{V}$  to  $5.5\text{V}$  for  $f_{SCLK} = 1\text{ MHz}$  to  $5\text{ MHz}$ ;  $f_{IN} = 20\text{ kHz}$ , and  $C_L = 25\text{ pF}$ , unless otherwise noted. Maximum and minimum values apply for  $T_A = T_{MIN}$  to  $T_{MAX}$ ; the typical values apply for  $T_A = 25^\circ\text{C}$ .

| Parameter                            |                         | Test Conditions                   | Min | Typ | Max | Units       |
|--------------------------------------|-------------------------|-----------------------------------|-----|-----|-----|-------------|
| <b>AC ELECTRICAL CHARACTERISTICS</b> |                         |                                   |     |     |     |             |
| $f_{SCLK}$                           | Maximum Clock Frequency |                                   | 1   |     | 5   | MHz         |
| $f_S$                                | Maximum Sample Rate     | See <sup>(4)</sup>                | 50  |     | 250 | kSPS        |
| $t_{ACQ}$                            | Acquisition/Track Time  |                                   | 600 |     |     | ns          |
| $t_{CONV}$                           | Conversion/Hold Time    |                                   |     |     | 17  | SCLK cycles |
| $t_{AD}$                             | Aperture Delay          | See the Specification Definitions |     | 6   |     | ns          |

(4) While the maximum sample rate is  $f_{SCLK} / 20$ , the actual sample rate may be lower than this by having the  $\overline{CS}$  rate slower than  $f_{SCLK} / 20$ .

## SM73201 Timing Specifications <sup>(1)</sup>

The following specifications apply for  $V_A = 4.5\text{V}$  to  $5.5\text{V}$ ,  $V_{IO} = 2.7\text{V}$  to  $5.5\text{V}$ ,  $V_{REF} = 2.5\text{V}$  to  $5.5\text{V}$ ,  $f_{SCLK} = 1\text{ MHz}$  to  $5\text{ MHz}$ , and  $C_L = 25\text{ pF}$ , unless otherwise noted. Maximum and minimum values apply for  $T_A = T_{MIN}$  to  $T_{MAX}$ ; the typical values apply for  $T_A = 25^\circ\text{C}$ .

| Parameter |                                                                                | Min | Typ | Max | Units |
|-----------|--------------------------------------------------------------------------------|-----|-----|-----|-------|
| $t_{CSS}$ | $\overline{CS}$ Setup Time prior to an SCLK rising edge                        | 8   | 3   |     | ns    |
| $t_{CSH}$ | $\overline{CS}$ Hold Time after an SCLK rising edge                            | 8   | 3   |     | ns    |
| $t_{DH}$  | $D_{OUT}$ Hold Time after an SCLK falling edge                                 | 6   | 11  |     | ns    |
| $t_{DA}$  | $D_{OUT}$ Access Time after an SCLK falling edge                               |     | 18  | 41  | ns    |
| $t_{DIS}$ | $D_{OUT}$ Disable Time after the rising edge of $\overline{CS}$ <sup>(2)</sup> |     | 20  | 30  | ns    |
| $t_{CS}$  | Minimum $\overline{CS}$ Pulse Width                                            | 20  |     |     | ns    |
| $t_{EN}$  | $D_{OUT}$ Enable Time after the 2nd falling edge of SCLK                       |     | 20  | 70  | ns    |
| $t_{CH}$  | SCLK High Time                                                                 | 20  |     |     | ns    |
| $t_{CL}$  | SCLK Low Time                                                                  | 20  |     |     | ns    |
| $t_r$     | $D_{OUT}$ Rise Time                                                            |     | 7   |     | ns    |
| $t_f$     | $D_{OUT}$ Fall Time                                                            |     | 7   |     | ns    |

(1) Typical values are at  $T_J = 25^\circ\text{C}$  and represent most likely parametric norms. Test limits are ensured to TI's AOQL (Average Outgoing Quality Level).

(2)  $t_{DIS}$  is the time for  $D_{OUT}$  to change 10% while being loaded by the Timing Test Circuit.

## Timing Diagrams

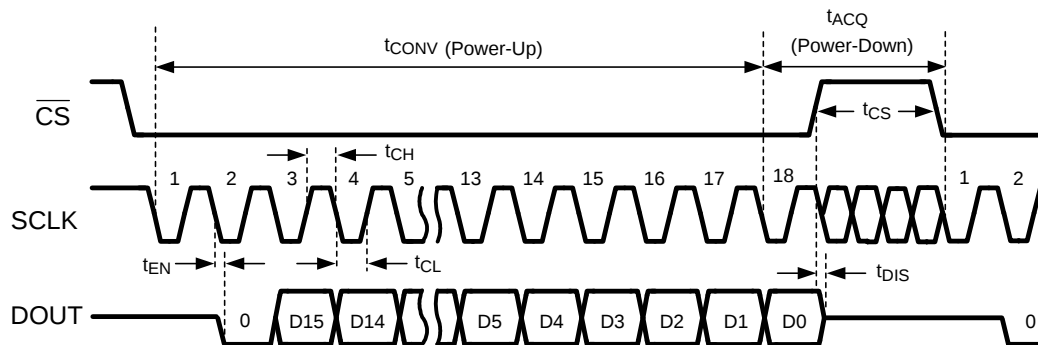
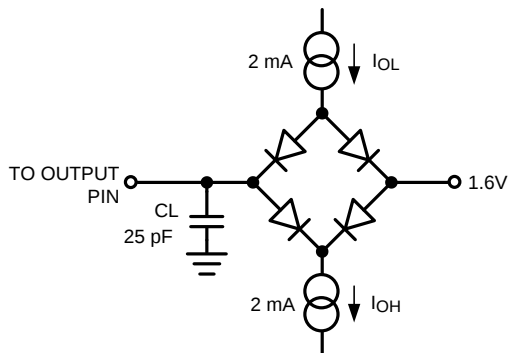


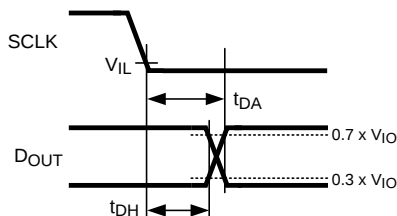
Figure 2. SM73201 Single Conversion Timing Diagram



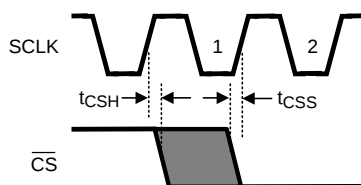
**Figure 3. Timing Test Circuit**



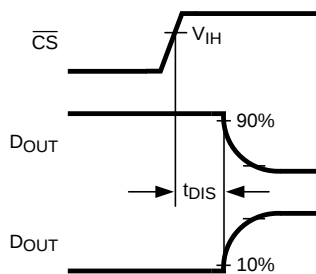
**Figure 4. D<sub>OUT</sub> Rise and Fall Times**



**Figure 5. D<sub>OUT</sub> Hold and Access Times**



**Figure 6. Valid  $\overline{\text{CS}}$  Assertion Times**



**Figure 7. Voltage Waveform for t<sub>DIS</sub>**

## Specification Definitions

**APERTURE DELAY** is the time between the first falling edge of SCLK and the time when the input signal is sampled for conversion.

**COMMON MODE REJECTION RATIO (CMRR)** is a measure of how well in-phase signals common to both input pins are rejected.

To calculate CMRR, the change in output offset is measured while the common mode input voltage is changed from 2V to 3V.

$$\text{CMRR} = 20 \text{ LOG } (\Delta \text{ Common Input} / \Delta \text{ Output Offset})$$

**CONVERSION TIME** is the time required, after the input voltage is acquired, for the ADC to convert the input voltage to a digital word.

**DIFFERENTIAL NON-LINEARITY (DNL)** is the measure of the maximum deviation from the ideal step size of 1 LSB.

**DUTY CYCLE** is the ratio of the time that a repetitive digital waveform is high to the total time of one period. The specification here refers to the SCLK.

**EFFECTIVE NUMBER OF BITS (ENOB, or EFFECTIVE BITS)** is another method of specifying Signal-to-Noise and Distortion or SINAD. ENOB is defined as  $(\text{SINAD} - 1.76) / 6.02$  and says that the converter is equivalent to a perfect ADC of this (ENOB) number of bits.

**FULL POWER BANDWIDTH** is a measure of the frequency at which the reconstructed output fundamental drops 3 dB below its low frequency value for a full scale input.

**GAIN ERROR** is the deviation from the ideal slope of the transfer function. It is the difference between Positive Full-Scale Error and Negative Full-Scale Error and can be calculated as:

$$\text{Gain Error} = \text{Positive Full-Scale Error} - \text{Negative Full-Scale Error}$$

**INTEGRAL NON-LINEARITY (INL)** is a measure of the deviation of each individual code from a line drawn from  $\frac{1}{2}$  LSB below the first code transition through  $\frac{1}{2}$  LSB above the last code transition. The deviation of any given code from this straight line is measured from the center of that code value.

**MISSING CODES** are those output codes that will never appear at the ADC outputs. The SM73201 is specified not to have any missing codes.

**NEGATIVE FULL-SCALE ERROR** is the difference between the differential input voltage at which the output code transitions from code 0x8001h to 0x8000h and  $-V_{\text{REF}} + 1 \text{ LSB}$ .

**NEGATIVE GAIN ERROR** is the difference between the negative full-scale error and the offset error.

**OFFSET ERROR** is the difference between the differential input voltage at which the output code transitions from code 0x0000h to 0x0001h and 1 LSB.

**POSITIVE FULL-SCALE ERROR** is the difference between the differential input voltage at which the output code transitions from code 0xFFFFh to 0xFFFEh and  $V_{\text{REF}} - 1 \text{ LSB}$ .

**POSITIVE GAIN ERROR** is the difference between the positive full-scale error and the offset error.

**POWER SUPPLY REJECTION RATIO (PSRR)** is a measure of how well a change in the analog supply voltage is rejected. PSRR is calculated from the ratio of the change in offset error for a given change in supply voltage, expressed in dB. For the SM73201,  $V_A$  is changed from 4.5V to 5.5V.

$$\text{PSRR} = 20 \text{ LOG } (\Delta \text{Output Offset} / \Delta V_A)$$

**SIGNAL TO NOISE RATIO (SNR)** is the ratio, expressed in dB, of the rms value of the input signal to the rms value of the sum of all other spectral components below one-half the sampling frequency, not including harmonics or d.c.

**SIGNAL TO NOISE PLUS DISTORTION (S/N+D or SINAD)** is the ratio, expressed in dB, of the rms value of the input signal to the rms value of all of the other spectral components below one-half the sampling frequency, including harmonics but excluding d.c.

**SPURIOUS FREE DYNAMIC RANGE (SFDR)** is the difference, expressed in dB, between the desired signal amplitude to the amplitude of the peak spurious spectral component below one-half the sampling frequency, where a spurious spectral component is any signal present in the output spectrum that is not present at the input and may or may not be a harmonic.

**TOTAL HARMONIC DISTORTION (THD)** is the ratio of the rms total of the first five harmonic components at the output to the rms level of the input signal frequency as seen at the output, expressed in dB. THD is calculated as

$$\text{THD} = 20 \times \log_{10} \sqrt{\frac{A_{f2}^2 + A_{f3}^2 + A_{f4}^2 + A_{f5}^2 + A_{f6}^2}{A_{f1}^2}}$$

where

- $A_{f1}$  is the RMS power of the input frequency at the output and  $A_{f2}$  through  $A_{f6}$  are the RMS power in the first 5 harmonic frequencies.

**THROUGHPUT TIME** is the minimum time required between the start of two successive conversion.

## Typical Performance Characteristics

$V_A = V_{IO} = V_{REF} = +5V$ ,  $f_{SCLK} = 5\text{ MHz}$ ,  $f_{SAMPLE} = 250\text{ kSPS}$ ,  $T_A = +25^\circ\text{C}$ , and  $f_{IN} = 20\text{ kHz}$  unless otherwise stated.

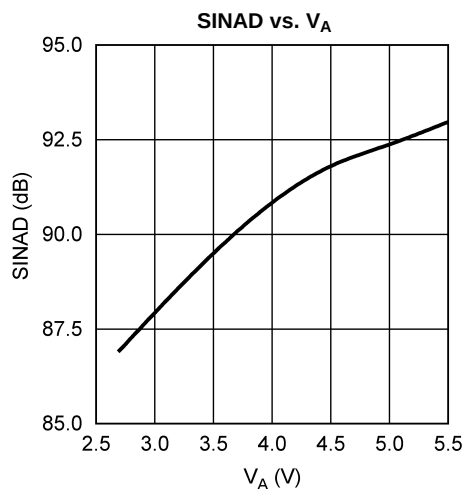


Figure 8.

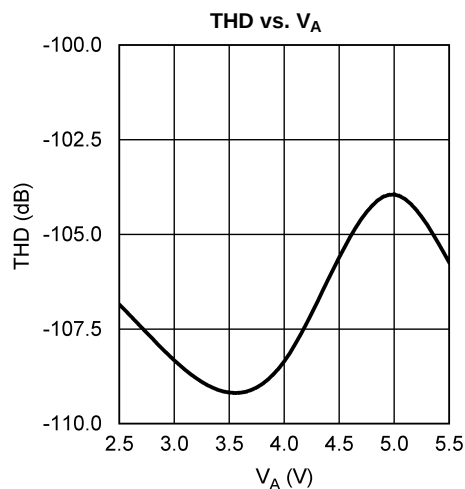


Figure 9.

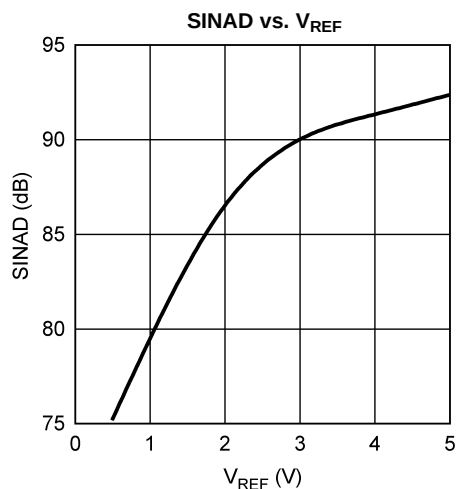


Figure 10.

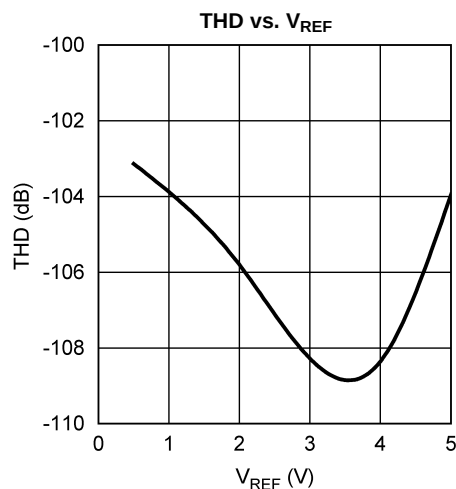


Figure 11.

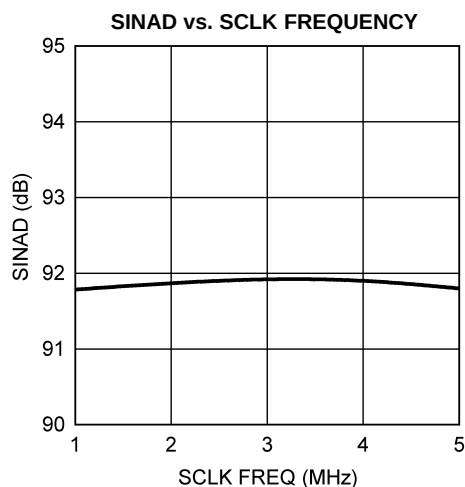


Figure 12.

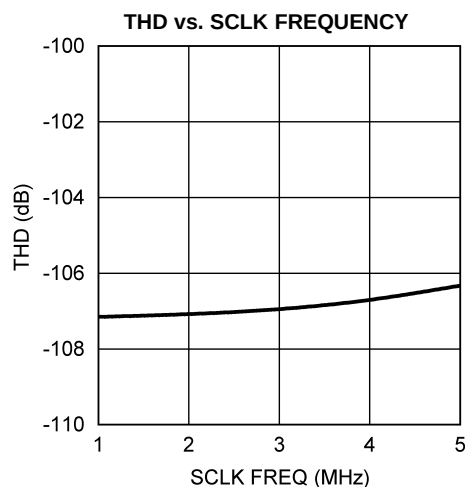


Figure 13.

## Typical Performance Characteristics (continued)

$V_A = V_{IO} = V_{REF} = +5V$ ,  $f_{SCLK} = 5\text{ MHz}$ ,  $f_{SAMPLE} = 250\text{ kSPS}$ ,  $T_A = +25^\circ\text{C}$ , and  $f_{IN} = 20\text{ kHz}$  unless otherwise stated.

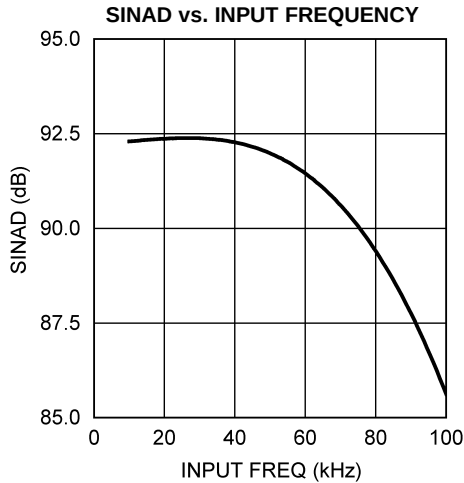


Figure 14.

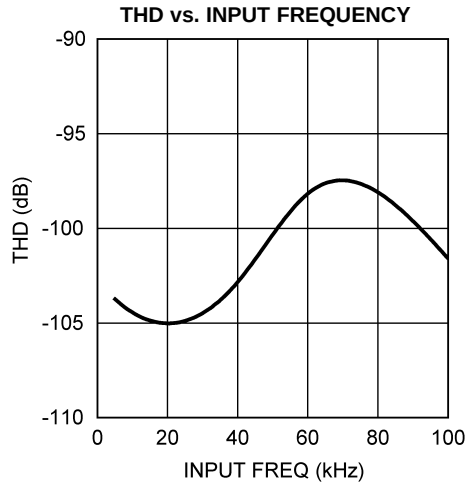


Figure 15.

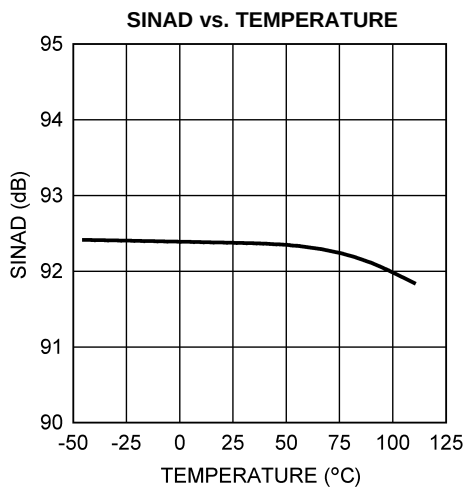


Figure 16.

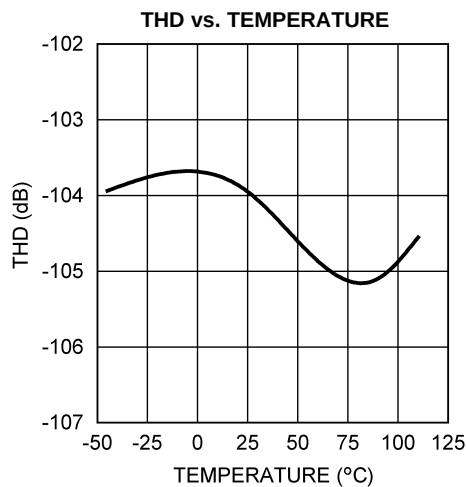


Figure 17.

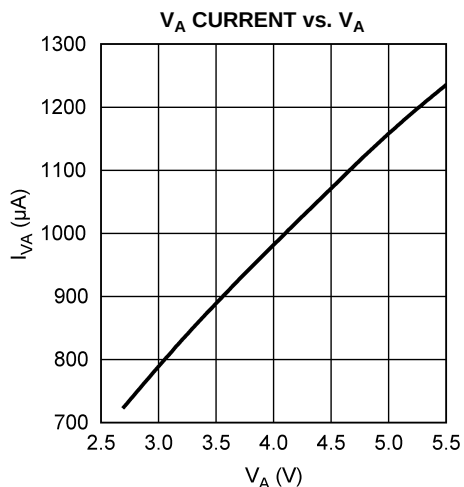


Figure 18.

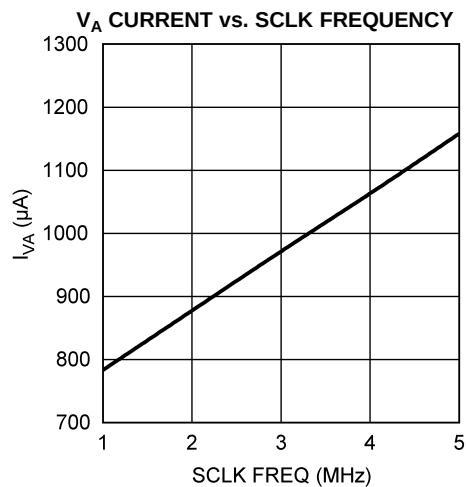


Figure 19.

### Typical Performance Characteristics (continued)

$V_A = V_{IO} = V_{REF} = +5V$ ,  $f_{SCLK} = 5\text{ MHz}$ ,  $f_{SAMPLE} = 250\text{ kSPS}$ ,  $T_A = +25^\circ\text{C}$ , and  $f_{IN} = 20\text{ kHz}$  unless otherwise stated.

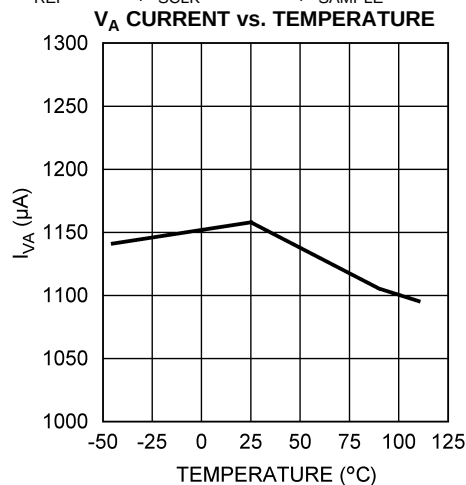


Figure 20.

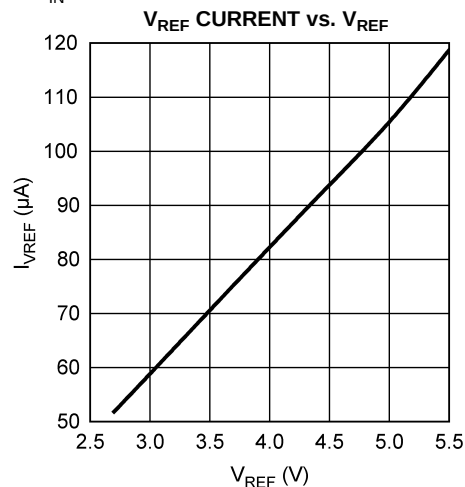


Figure 21.

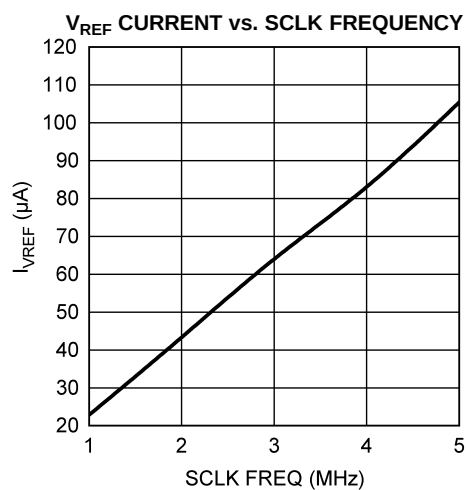


Figure 22.

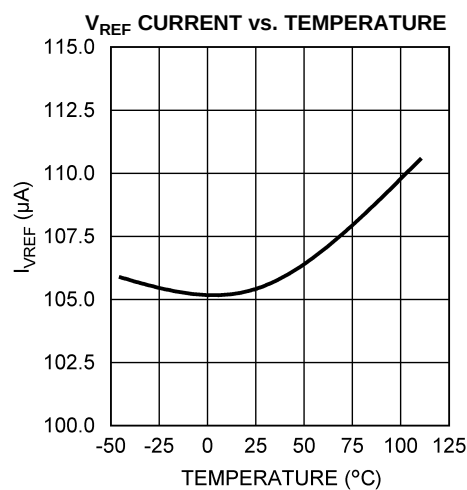


Figure 23.

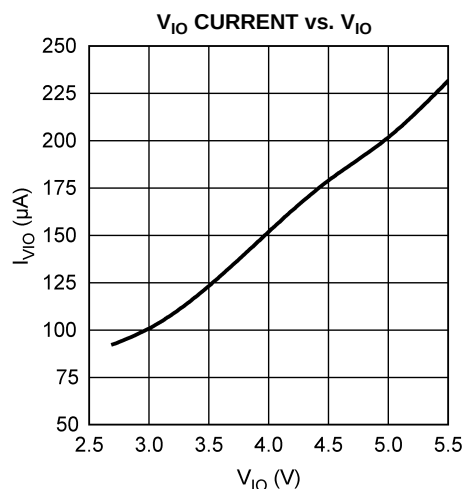


Figure 24.

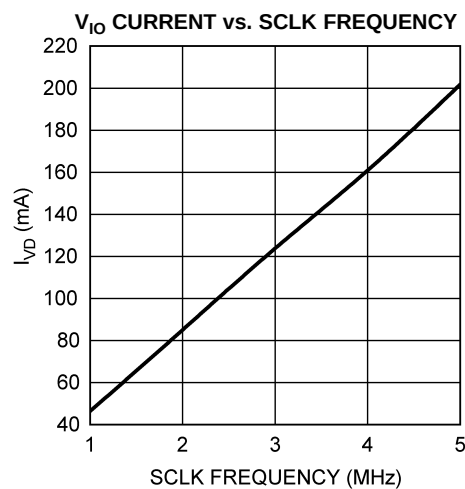


Figure 25.

### Typical Performance Characteristics (continued)

$V_A = V_{IO} = V_{REF} = +5V$ ,  $f_{SCLK} = 5\text{ MHz}$ ,  $f_{SAMPLE} = 250\text{ kSPS}$ ,  $T_A = +25^\circ\text{C}$ , and  $f_{IN} = 20\text{ kHz}$  unless otherwise stated.

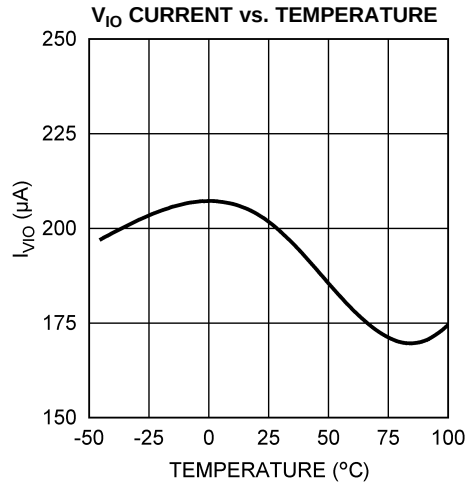


Figure 26.

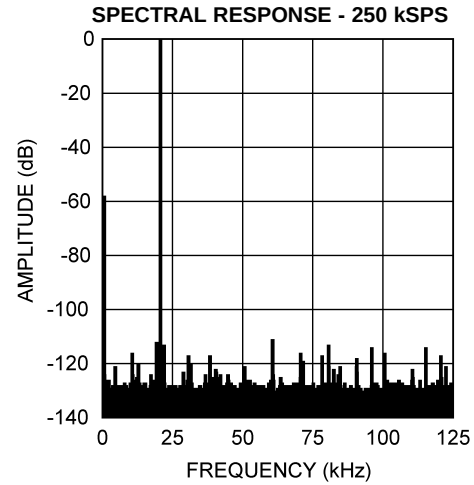


Figure 27.

## FUNCTIONAL DESCRIPTION

The SM73201 is a 16-bit, 50 kSPS to 250 kSPS sampling Analog-to-Digital (A/D) converter. The converter uses a successive approximation register (SAR) architecture based upon capacitive redistribution containing an inherent sample-and-hold function. The differential nature of the analog inputs is maintained from the internal sample-and-hold circuits throughout the A/D converter to provide excellent common-mode signal rejection.

The SM73201 operates from independent analog and digital supplies. The analog supply ( $V_A$ ) can range from 4.5V to 5.5V and the digital input/output supply ( $V_{IO}$ ) can range from 2.7V to 5.5V. The SM73201 utilizes an external reference ( $V_{REF}$ ), which can be any voltage between 0.5V and  $V_A$ . The value of  $V_{REF}$  determines the range of the analog input, while the reference input current ( $I_{REF}$ ) depends upon the conversion rate.

The analog input is presented to two input pins: +IN and –IN. Upon initiation of a conversion, the differential input at these pins is sampled on the internal capacitor array. The inputs are disconnected from the internal circuitry while a conversion is in progress. The SM73201 features a zero-power track mode (ZPTM) where the ADC is consuming the minimum amount of power (Power-Down Mode) while the internal sampling capacitor array is tracking the applied analog input voltage. The converter enters ZPTM at the end of each conversion window and experiences no delay when the ADC enters into Conversion Mode. This feature allows the user an easy means for optimizing system performance based on the settling capability of the analog source while minimizing power consumption. ZPTM is exercised by bringing chip select bar ( $\overline{CS}$ ) high or when  $\overline{CS}$  is held low after the conversion is complete (after the 18<sup>th</sup> falling edge of the serial clock).

The SM73201 communicates with other devices via a Serial Peripheral Interface (SPI), a synchronous serial interface that operates using three pins: chip select bar ( $\overline{CS}$ ), serial clock (SCLK), and serial data out ( $D_{OUT}$ ). The external SCLK controls data transfer and serves as the conversion clock. The duty cycle of SCLK is essentially unimportant, provided the minimum clock high and low times are met. The minimum SCLK frequency is set by internal capacitor leakage. Each conversion requires a minimum of 18 SCLK cycles to complete. If less than 16 bits of conversion data are required,  $\overline{CS}$  can be brought high at any point during the conversion. This procedure of terminating a conversion prior to completion is commonly referred to as short cycling.

The digital conversion result is clocked out by the SCLK input and is provided serially, most significant bit (MSB) first, at the  $D_{OUT}$  pin. The digital data that is provided at the  $D_{OUT}$  pin is that of the conversion currently in progress and thus there is no pipe line delay or latency.

### REFERENCE INPUT ( $V_{REF}$ )

The externally supplied reference voltage ( $V_{REF}$ ) sets the analog input range. The SM73201 will operate with  $V_{REF}$  in the range of 0.5V to  $V_A$ .

Operation with  $V_{REF}$  below 2.5V is possible with slightly diminished performance. As  $V_{REF}$  is reduced, the range of acceptable analog input voltages is reduced. Assuming a proper common-mode input voltage ( $V_{CM}$ ), the differential peak-to-peak input range is limited to  $(2 \times V_{REF})$ . See [Input Common Mode Voltage](#) for more details.

Reducing  $V_{REF}$  also reduces the size of the least significant bit (LSB). For example, the size of one LSB is equal to  $[(2 \times V_{REF}) / 2^n]$ , which is 152.6  $\mu$ V where n is 16 bits and  $V_{REF}$  is 5V. When the LSB size goes below the noise floor of the SM73201, the noise will span an increasing number of codes and overall performance will suffer. Dynamic signals will have their SNR degrade; while, D.C. measurements will have their code uncertainty increase. Since the noise is Gaussian in nature, the effects of this noise can be reduced by averaging the results of a number of consecutive conversions.

$V_{REF}$  and analog inputs (+IN and -IN) are connected to the capacitor array through a switch matrix when the input is sampled. Hence,  $I_{REF}$ ,  $I_{+IN}$ , and  $I_{-IN}$  are a series of transient spikes that occur at a frequency dependent on the operating sample rate of the SM73201.

$I_{REF}$  changes only slightly with temperature. See the curves, “Figure 20” and “Figure 22” in the [Typical Performance Characteristics](#) section for additional details.

### ANALOG SIGNAL INPUTS

The SM73201 has a differential input where the effective input voltage that is digitized is (+IN) – (–IN).

## Differential Input Operation

The transfer curve of the SM73201 for a fully differential input signal is shown in [Figure 28](#). A positive full scale output code (0111 1111 1111 1111b or 7FFFh or 32,767d) will be obtained when  $(+IN) - (-IN)$  is greater than or equal to  $(V_{REF} - 1 \text{ LSB})$ . A negative full scale code (1000 0000 0000 0000b or 8000h or -32,768d) will be obtained when  $[(+IN) - (-IN)]$  is less than or equal to  $(-V_{REF} + 1 \text{ LSB})$ . This ignores gain, offset and linearity errors, which will affect the exact differential input voltage that will determine any given output code.

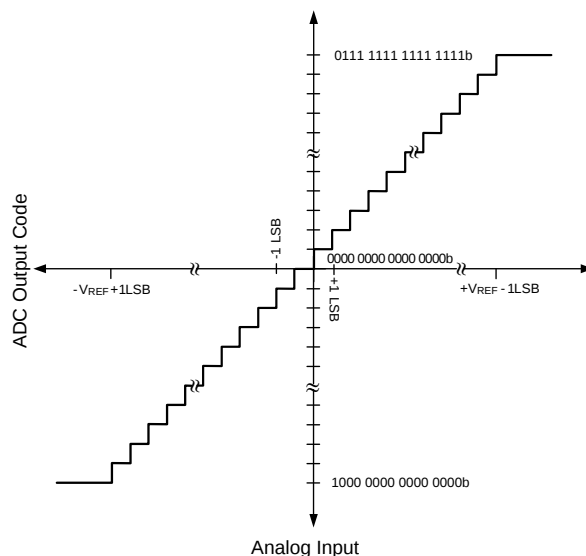


Figure 28. ADC Transfer Curve

Both inputs should be biased at a common mode voltage ( $V_{CM}$ ), which will be thoroughly discussed in [Input Common Mode Voltage](#) [Figure 29](#) shows the SM73201 being driven by a full-scale differential source.

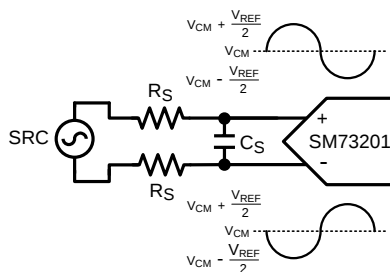


Figure 29. Differential Input

## Single-Ended Input Operation

For single-ended operation, the non-inverting input ( $+IN$ ) of the SM73201 can be driven with a signal that has a peak-to-peak range that is equal to or less than  $(2 \times V_{REF})$ . The inverting input ( $-IN$ ) should be biased at a stable  $V_{CM}$  that is halfway between these maximum and minimum values. In order to utilize the entire dynamic range of the SM73201,  $V_{REF}$  is limited to  $(V_A / 2)$ . This allows  $+IN$  a maximum swing range of ground to  $V_A$ . [Figure 30](#) shows the SM73201 being driven by a full-scale single-ended source.

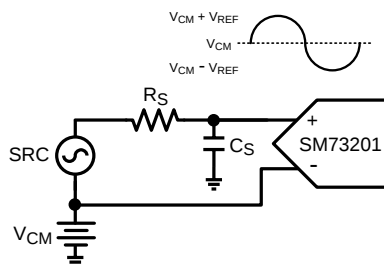
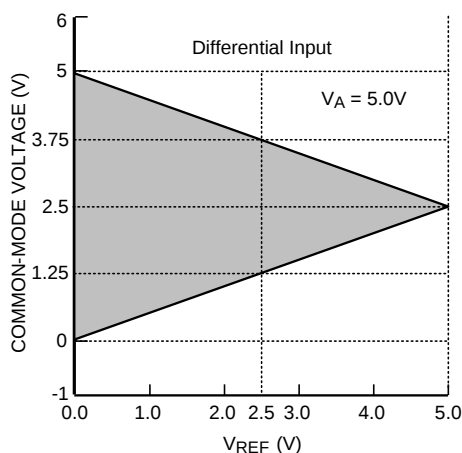


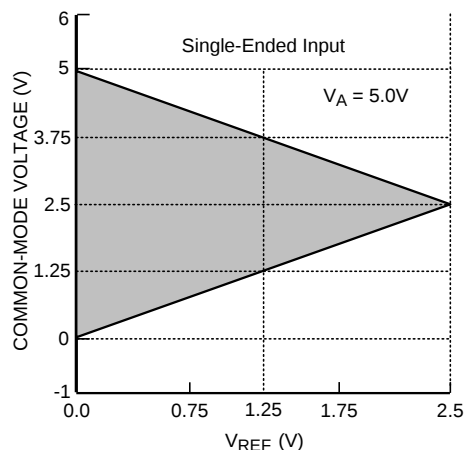
Figure 30. Single-Ended Input

Since the design of the SM73201 is optimized for a differential input, the performance degrades slightly when driven with a single-ended input. Linearity characteristics such as INL and DNL typically degrade by 0.1 LSB and dynamic characteristics such as SINAD typically degrade by 2 dB. Note that single-ended operation should only be used if the performance degradation (compared with differential operation) is acceptable.

### Input Common Mode Voltage

The allowable input common mode voltage ( $V_{CM}$ ) range depends upon  $V_A$  and  $V_{REF}$  used for the SM73201. The ranges of  $V_{CM}$  are depicted in Figure 31 and Figure 32. Note that these figures only apply to a  $V_A$  of 5V. Equations for calculating the minimum and maximum  $V_{CM}$  for differential and single-ended operations are shown in Table 1.

Figure 31.  $V_{CM}$  range for Differential Input operation



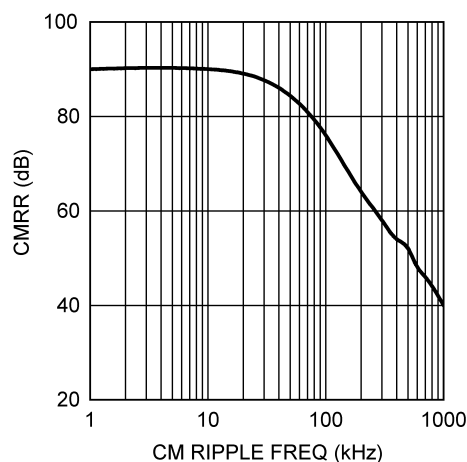
**Figure 32.  $V_{CM}$  range for single-ended operation**

**Table 1. Allowable  $V_{CM}$  Range**

| Input Signal | Minimum $V_{CM}$ | Maximum $V_{CM}$    |
|--------------|------------------|---------------------|
| Differential | $V_{REF} / 2$    | $V_A - V_{REF} / 2$ |
| Single-Ended | $V_{REF}$        | $V_A - V_{REF}$     |

### CMRR

By using this differential input, small signals common to both inputs are rejected. As shown in Figure 33, noise is immune at low frequencies where the common-mode rejection ratio (CMRR) is 90 dB. As the frequency increases to 1 MHz, the CMRR rolls off to 40 dB. In general, operation with a fully differential input signal or voltage will provide better performance than with a single-ended input. However, if desired, the SM73201 can be presented with a single-ended input.



**Figure 33. Analog Input CMRR vs. Frequency**

## Input Settling

When the SM73201 enters acquisition ( $t_{ACQ}$ ) mode at the end of the conversion window, the internal sampling capacitor ( $C_{SAMPLE}$ ) is connected to the ADC input via an internal switch and a series resistor ( $R_{SAMPLE}$ ), as shown in Figure 34. Typical values for  $C_{SAMPLE}$  and  $R_{SAMPLE}$  are 20 pF and 200 ohms respectively. If there is not a large external capacitor ( $C_{EXT}$ ) at the analog input of the ADC, a voltage spike will be observed at the input pins. This is a result of  $C_{SAMPLE}$  and  $C_{EXT}$  being at different voltage potentials. The magnitude and direction of the voltage spike depend on the difference between the voltage of  $C_{SAMPLE}$  and  $C_{EXT}$ . If the voltage at  $C_{SAMPLE}$  is greater than the voltage at  $C_{EXT}$ , a positive voltage spike will occur. If the opposite is true, a negative voltage spike will occur. It is not critical for the performance of the SM73201 to filter out the voltage spike. Rather, ensure that the transient of the spike settles out within  $t_{ACQ}$ ; for recommended solutions, see [ANALOG INPUT CONSIDERATIONS](#) in the Application Information.

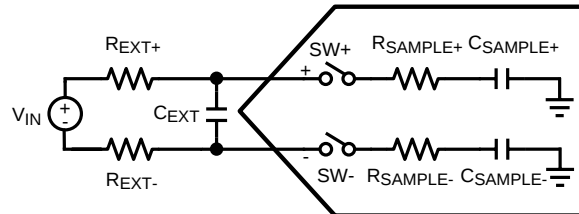


Figure 34. ADC Input Capacitors

## SERIAL DIGITAL INTERFACE

The SM73201 communicates via a synchronous 3-wire serial interface as shown in Figure 2 or re-shown in Figure 35 for convenience.  $\overline{CS}$ , chip select bar, initiates conversions and frames the serial data transfers. SCLK (serial clock) controls both the conversion process and the timing of the serial data.  $D_{OUT}$  is the serial data output pin, where a conversion result is sent as a serial data stream, MSB first.

A serial frame is initiated on the falling edge of  $\overline{CS}$  and ends on the rising edge of  $\overline{CS}$ . The SM73201's  $D_{OUT}$  pin is in a high impedance state when  $\overline{CS}$  is high and for the first clock period after  $\overline{CS}$  is asserted;  $D_{OUT}$  is active for the remainder of time when  $\overline{CS}$  is asserted.

The SM73201 samples the differential input upon the assertion of  $\overline{CS}$ . Assertion is defined as bringing the  $\overline{CS}$  pin to a logic low state. For the first 17 periods of the SCLK following the assertion of  $\overline{CS}$ , the SM73201 is converting the analog input voltage. On the 18<sup>th</sup> falling edge of SCLK, the SM73201 enters acquisition ( $t_{ACQ}$ ) mode. For the next three periods of SCLK, the SM73201 is operating in acquisition mode where the ADC input is tracking the analog input signal applied across +IN and -IN. During acquisition mode, the SM73201 is consuming a minimal amount of power.

The SM73201 can enter conversion mode ( $t_{CONV}$ ) under three different conditions. The first condition involves  $\overline{CS}$  going low (asserted) with SCLK high. In this case, the SM73201 enters conversion mode on the first falling edge of SCLK after  $\overline{CS}$  is asserted. In the second condition,  $\overline{CS}$  goes low with SCLK low. Under this condition, the SM73201 automatically enters conversion mode and the falling edge of  $\overline{CS}$  is seen as the first falling edge of SCLK. In the third condition,  $\overline{CS}$  and SCLK go low simultaneously and the SM73201 enters conversion mode. While there is no timing restriction with respect to the falling edges of  $\overline{CS}$  and SCLK, there are minimum setup and hold time requirements for the falling edge of  $\overline{CS}$  with respect to the rising edge of SCLK. See Figure 6 in the Timing Diagram section for more information.

## $\overline{CS}$ Input

The  $\overline{CS}$  (chip select bar) input is active low and is CMOS compatible. The SM73201 enters conversion mode when  $\overline{CS}$  is asserted and the SCLK pin is in a logic low state. When  $\overline{CS}$  is high, the SM73201 is always in acquisition mode and thus consuming the minimum amount of power. Since  $\overline{CS}$  must be asserted to begin a conversion, the sample rate of the SM73201 is equal to the assertion rate of  $\overline{CS}$ .

Proper operation requires that the fall of  $\overline{CS}$  not occur simultaneously with a rising edge of SCLK. If the fall of  $\overline{CS}$  occurs during the rising edge of SCLK, the data might be clocked out one bit early. Whether or not the data is clocked out early depends upon how close the  $\overline{CS}$  transition is to the SCLK transition, the device temperature, and the characteristics of the individual device. To ensure that the MSB is always clocked out at a given time (the 3<sup>rd</sup> falling edge of SCLK), it is essential that the fall of  $\overline{CS}$  always meet the timing requirement specified in the Timing Specification table.

### SCLK Input

The SCLK (serial clock) is used as the conversion clock to shift out the conversion result. SCLK is CMOS compatible. Internal settling time requirements limit the maximum clock frequency while internal capacitor leakage limits the minimum clock frequency. The SM73201 offers specified performance with the clock rates indicated in the electrical table.

The SM73201 enters acquisition mode on the 18<sup>th</sup> falling edge of SCLK during a conversion frame. Assuming that the LSB is clocked into a controller on the 18<sup>th</sup> rising edge of SCLK, there is a minimum acquisition time period that must be met before a new conversion frame can begin. Other than the 18<sup>th</sup> rising edge of SCLK that was used to latch the LSB into a controller, there is no requirement for the SCLK to transition during acquisition mode. Therefore, it is acceptable to idle SCLK after the LSB has been latched into the controller.

### Data Output

The data output format of the SM73201 is two's complement as shown in Figure 28. This figure indicates the ideal output code for a given input voltage and does not include the effects of offset, gain error, linearity errors, or noise. Each data output bit is output on the falling edges of SCLK.  $D_{OUT}$  is in a high impedance state for the 1<sup>st</sup> falling edge of SCLK while the 2<sup>nd</sup> SCLK falling edge clocks out a leading zero. The 3<sup>rd</sup> to 18<sup>th</sup> SCLK falling edges clock out the conversion result, MSB first.

While most receiving systems will capture the digital output bits on the rising edges of SCLK, the falling edges of SCLK may be used to capture the conversion result if the minimum hold time for  $D_{OUT}$  is acceptable. See Figure 5 for  $D_{OUT}$  hold ( $t_{DH}$ ) and access ( $t_{DA}$ ) times.

$D_{OUT}$  is enabled on the second falling edge of SCLK after the assertion of  $\overline{CS}$  and is disabled on the rising edge of  $\overline{CS}$ . If  $\overline{CS}$  is raised prior to the 18<sup>th</sup> falling edge of SCLK, the current conversion is aborted and  $D_{OUT}$  will go into its high impedance state. A new conversion will begin when  $\overline{CS}$  is driven LOW.

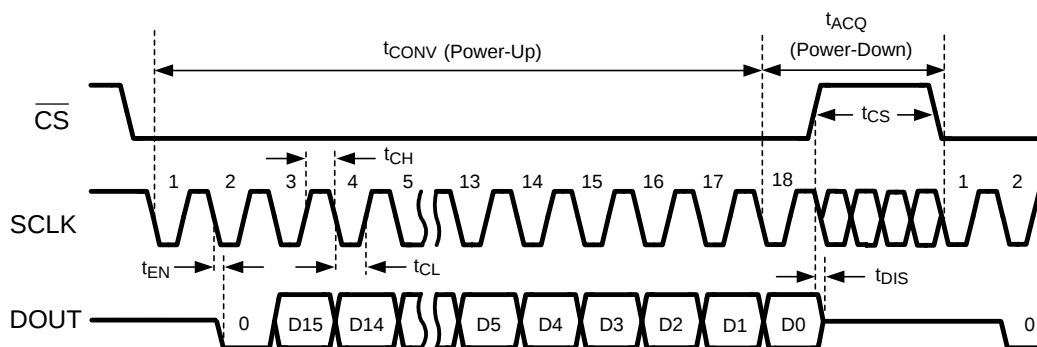


Figure 35. SM73201 Single Conversion Timing Diagram

## Applications Information

### OPERATING CONDITIONS

We recommend that the following conditions be observed for operation of the SM73201:

$$-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$$

$$+4.5\text{V} \leq V_A \leq +5.5\text{V}$$

$$+2.7\text{V} \leq V_{\text{IO}} \leq +5.5\text{V}$$

$$+0.5\text{V} \leq V_{\text{REF}} \leq +5.5\text{V}$$

$$1\text{ MHz} \leq f_{\text{SCLK}} \leq 5\text{ MHz}$$

$V_{\text{CM}}$ : See [Input Common Mode Voltage](#)

### ANALOG INPUT CONSIDERATIONS

As stated previously in [Input Settling](#), it is not critical for the performance of the SM73201 to filter out the voltage spike that occurs when the SM73201 enters acquisition ( $t_{\text{ACQ}}$ ) mode at the end of the conversion window. However, it is critical that a system designer ensures that the transients of the spike settle out within  $t_{\text{ACQ}}$ . The burden of this task can be placed on the analog source itself or the burden can be shared by the source and an external capacitor,  $C_{\text{EXT}}$  as shown in [Figure 34](#). The external capacitor acts as a local charge reservoir for the internal sampling capacitor and thus reduces the size of the voltage spike. For low frequency analog sources such as sensors with DC-like output behaviors,  $C_{\text{EXT}}$  values greater than 1 nF are recommended. However, some sensors and signal conditioning circuitry will not be able to maintain their stability in the presence of the external capacitive load. In these instances, a series resistor ( $R_{\text{EXT}}$ ) is recommended. The magnitude of  $R_{\text{EXT}}$  is dependent on the output capability of the analog source and the settling requirement of the ADC. Independent of the presence of an external capacitor, the system designer always has the option of lowering the sample rate of the SM73201 which directly controls the amount of time allowed for the voltage spike to settle. The slower the sample rate, the longer the  $t_{\text{ACQ}}$  time or settling time. This is possible with the SM73201 since the converter enters  $t_{\text{ACQ}}$  at the end of the prior conversion and thus is tracking the analog input source the entire time between conversions.

### POWER CONSUMPTION

The architecture, design, and fabrication process allow the SM73201 to operate at conversion rates up to 250 kSPS while consuming very little power. The SM73201 consumes the least amount of power while operating in acquisition (power-down) mode. For applications where power consumption is critical, the SM73201 should be operated in acquisition mode as often as the application will tolerate. To further reduce power consumption, stop the SCLK while CS is high.

### Short Cycling

Short cycling refers to the process of halting a conversion after the last needed bit is outputted. Short cycling can be used to lower the power consumption in those applications that do not need a full 16-bit resolution, or where an analog signal is being monitored until some condition occurs. In some circumstances, the conversion could be terminated after the first few bits. This will lower power consumption in the converter since the SM73201 spends more time in acquisition mode and less time in conversion mode.

Short cycling is accomplished by pulling  $\overline{\text{CS}}$  high after the last required bit is received from the SM73201 output. This is possible because the SM73201 places the latest converted data bit on  $D_{\text{OUT}}$  as it is generated. If only 10-bits of the conversion result are needed, for example, the conversion can be terminated by pulling  $\overline{\text{CS}}$  high after the 10<sup>th</sup> bit has been clocked out.

### **Burst Mode Operation**

Normal operation of the SM73201 requires the SCLK frequency to be 20 times the sample rate and the  $\overline{\text{CS}}$  rate to be the same as the sample rate. However, in order to minimize power consumption in applications requiring sample rates below 250 kSPS, the SM73201 should be run with an SCLK frequency of 5 MHz and a  $\overline{\text{CS}}$  rate as slow as the system requires. When this is accomplished, the SM73201 is operating in burst mode. The SM73201 enters into acquisition mode at the end of each conversion, minimizing power consumption. This causes the converter to spend the longest possible time in acquisition mode. Since power consumption scales directly with conversion rate, minimizing power consumption requires determining the lowest conversion rate that will satisfy the requirements of the system.

### **PCB LAYOUT AND CIRCUIT CONSIDERATIONS**

For best performance, care should be taken with the physical layout of the printed circuit board. This is especially true with a low  $V_{\text{REF}}$  or when the conversion rate is high. At high clock rates there is less time for settling, so it is important that any noise settles out before the conversion begins.

#### **Analog and Digital Power Supplies**

Any ADC architecture is sensitive to spikes on the power supply, reference, and ground pins. These spikes may originate from switching power supplies, digital logic, high power devices, and other sources. Power to the SM73201 should be clean and well bypassed. A 0.1  $\mu\text{F}$  ceramic bypass capacitor and a 1  $\mu\text{F}$  to 10  $\mu\text{F}$  capacitor should be used to bypass the SM73201 supply, with the 0.1  $\mu\text{F}$  capacitor placed as close to the SM73201 package as possible.

Since the SM73201 has both the  $V_A$  and  $V_{\text{IO}}$  pins, the user has three options on how to connect these pins. The first option is to tie  $V_A$  and  $V_{\text{IO}}$  together and power them with the same power supply. This is the most cost effective way of powering the SM73201 but is also the least ideal. As stated previously, noise from  $V_{\text{IO}}$  can couple into  $V_A$  and adversely affect performance. The other two options involve the user powering  $V_A$  and  $V_{\text{IO}}$  with separate supply voltages. These supply voltages can have the same amplitude or they can be different.  $V_A$  can be set to any value between +4.5V and +5.5V; while  $V_{\text{IO}}$  can be set to any value between +2.7V and +5.5V.

Best performance will typically be achieved with  $V_A$  operating at 5V and  $V_{\text{IO}}$  at 3V. Operating  $V_A$  at 5V offers the best linearity and dynamic performance when  $V_{\text{REF}}$  is also set to 5V; while operating  $V_{\text{IO}}$  at 3V reduces the power consumption of the digital logic. Operating the digital interface at 3V also has the added benefit of decreasing the noise created by charging and discharging the capacitance of the digital interface pins.

#### **Voltage Reference**

The reference source must have a low output impedance and needs to be bypassed with a minimum capacitor value of 0.1  $\mu\text{F}$ . A larger capacitor value of 1  $\mu\text{F}$  to 10  $\mu\text{F}$  placed in parallel with the 0.1  $\mu\text{F}$  is preferred. While the SM73201 draws very little current from the reference on average, there are higher instantaneous current spikes at the reference.

$V_{\text{REF}}$  of the SM73201, like all A/D converters, does not reject noise or voltage variations. Keep this in mind if  $V_{\text{REF}}$  is derived from the power supply. Any noise and/or ripple from the supply that is not rejected by the external reference circuitry will appear in the digital results. The use of an active reference source is recommended. The LM4040 and LM4050 shunt reference families and the SM74601, LM4120, and LM4140 series reference families are excellent choices for a reference source.

#### **PCB Layout**

Capacitive coupling between the noisy digital circuitry and the sensitive analog circuitry can lead to poor performance. The solution is to keep the analog circuitry separated from the digital circuitry and the clock line as short as possible. Digital circuits create substantial supply and ground current transients. The logic noise generated could have significant impact upon system noise performance. To avoid performance degradation of the SM73201 due to supply noise, avoid using the same supply for the  $V_A$  and  $V_{\text{REF}}$  of the SM73201 that is used for digital circuitry on the board.

Generally, analog and digital lines should cross each other at 90° to avoid crosstalk. However, to maximize accuracy in high resolution systems, avoid crossing analog and digital lines altogether. It is important to keep clock lines as short as possible and isolated from ALL other lines, including other digital lines. In addition, the clock line should also be treated as a transmission line and be properly terminated. The analog input should be isolated from noisy signal traces to avoid coupling of spurious signals into the input. Any external component (e.g., a filter capacitor) connected between the converter's input pins and ground or to the reference input pin and ground should be connected to a very clean point in the ground plane.

A single, uniform ground plane and the use of split power planes are recommended. The power planes should be located within the same board layer. All analog circuitry (input amplifiers, filters, reference components, etc.) should be placed over the analog power plane. All digital circuitry should be placed over the digital power plane. Furthermore, the GND pins on the SM73201 and all the components in the reference circuitry and input signal chain that are connected to ground should be connected to the ground plane at a quiet point. Avoid connecting these points too close to the ground point of a microprocessor, microcontroller, digital signal processor, or other high power digital device.

## APPLICATION CIRCUITS

The following figures are examples of the SM73201 in typical application circuits. These circuits are basic and will generally require modification for specific circumstances.

### Data Acquisition

Figure 36 shows a typical connection diagram for the SM73201 operating at  $V_A$  of +5V.  $V_{REF}$  is connected to a 2.5V shunt reference, the LM4020-2.5, to define the analog input range of the SM73201 independent of supply variation on the +5V supply line. The  $V_{REF}$  pin should be de-coupled to the ground plane by a 0.1  $\mu$ F ceramic capacitor and a tantalum capacitor of 10  $\mu$ F. It is important that the 0.1  $\mu$ F capacitor be placed as close as possible to the  $V_{REF}$  pin while the placement of the tantalum capacitor is less critical. It is also recommended that the  $V_A$  and  $V_{IO}$  pins of the SM73201 be de-coupled to ground by a 0.1  $\mu$ F ceramic capacitor in parallel with a 10  $\mu$ F tantalum capacitor.

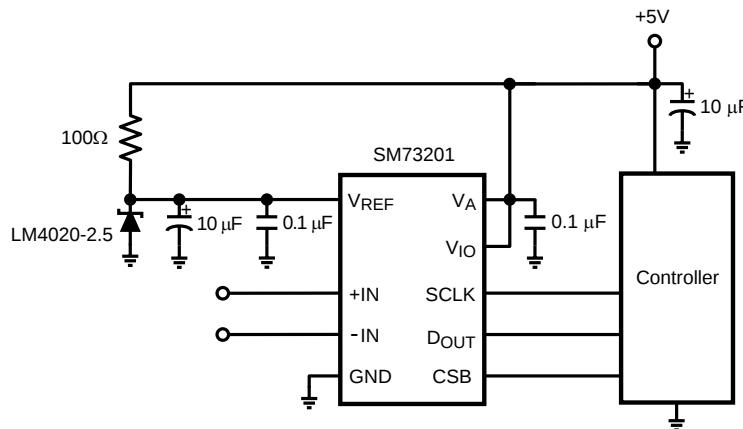


Figure 36. Low cost, low power Data Acquisition System

## REVISION HISTORY

| Changes from Revision A (March 2013) to Revision B         | Page               |
|------------------------------------------------------------|--------------------|
| • Changed layout of National Data Sheet to TI format ..... | <a href="#">22</a> |

## PACKAGING INFORMATION

| Orderable part number            | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|----------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">SM73201IMM/NOPB</a>  | Active        | Production           | VSSOP (DGS)   10 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 85    | S201                |
| SM73201IMM/NOPB.A                | Active        | Production           | VSSOP (DGS)   10 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 85    | S201                |
| <a href="#">SM73201IMME/NOPB</a> | Active        | Production           | VSSOP (DGS)   10 | 250   SMALL T&R       | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 85    | S201                |
| SM73201IMME/NOPB.A               | Active        | Production           | VSSOP (DGS)   10 | 250   SMALL T&R       | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 85    | S201                |
| <a href="#">SM73201IMMX/NOPB</a> | Active        | Production           | VSSOP (DGS)   10 | 3500   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 85    | S201                |
| SM73201IMMX/NOPB.A               | Active        | Production           | VSSOP (DGS)   10 | 3500   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 85    | S201                |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

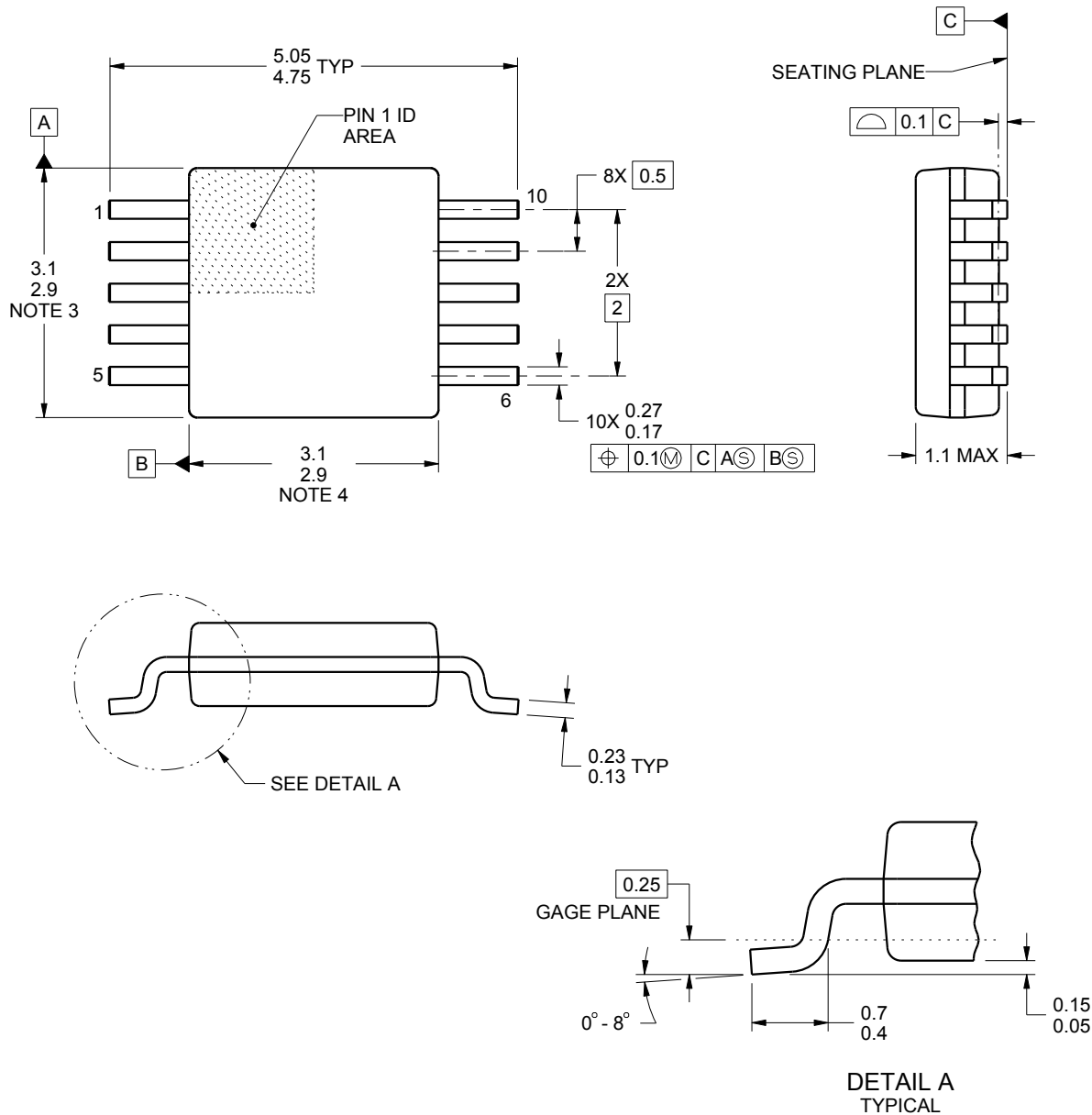
| Device           | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SM73201IMM/NOPB  | VSSOP        | DGS             | 10   | 1000 | 177.8              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| SM73201IMME/NOPB | VSSOP        | DGS             | 10   | 250  | 177.8              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| SM73201IMMX/NOPB | VSSOP        | DGS             | 10   | 3500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SM73201IMM/NOPB  | VSSOP        | DGS             | 10   | 1000 | 208.0       | 191.0      | 35.0        |
| SM73201IMME/NOPB | VSSOP        | DGS             | 10   | 250  | 208.0       | 191.0      | 35.0        |
| SM73201IMMX/NOPB | VSSOP        | DGS             | 10   | 3500 | 367.0       | 367.0      | 35.0        |



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**NOTES:**

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-187, variation BA.

# EXAMPLE BOARD LAYOUT

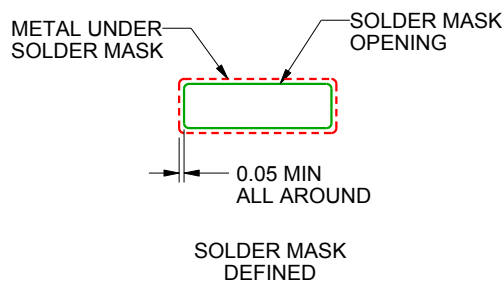
DGS0010A

VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
SCALE:10X



SOLDER MASK DETAILS  
NOT TO SCALE

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NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

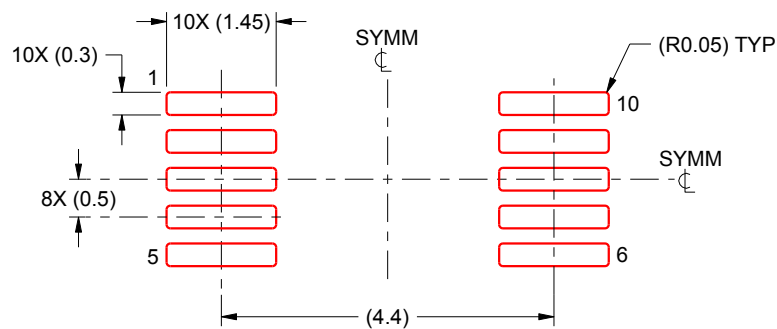
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DGS0010A

VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:10X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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